VEMD6110X01

Vishay Semiconductors



Silicon PIN Photodiode



DESCRIPTION

VEMD6110X01 is a high speed and high sensitive PIN photodiode. It is a small surface mount device (SMD) including the chip with a 0.85 mm² sensitive area and a daylight blocking filter matched with IR emitters operating at wavelength of 830 nm to 950 nm.

FEATURES

- · Package type: surface-mount
- Package form: 1206
- Dimensions (L x W x H in mm): 4 x 2 x 1.05
- Radiant sensitive area (in mm²): 0.85
- · High photo sensitivity
- High sensitivity
- Daylight blocking filter matched with 830 nm to 950 nm emitters
- Fast response times
- Angle of half sensitivity: $\varphi = \pm 60^{\circ}$
- Floor life: 72 h, MSL 4, according to J-STD-020
- · Lead (Pb)-free reflow soldering
- AEC-Q101 qualified
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

• High speed photo detector

PRODUCT SUMMARY COMPONENT Ira (μA) φ (°) λ_{0.5} (nm) VEMD6110X01 9.5 ± 60 750 to 1050

Note

Test conditions see table "Basic Characteristics"

ORDERING INFORMATION

ORDERING CODE	PACKAGING	REMARKS	PACKAGE FORM			
VEMD6110X01	Tape and reel	MOQ: 3000 pcs, 3000 pcs/reel	1206			

Note

MOQ: minimum order quantity

ABSOLUTE MAXIMUM RATINGS (T _{amb} = 25 °C, unless otherwise specified)							
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT			
Reverse voltage		V _R	32	V			
Power dissipation	T _{amb} ≤ 25 °C	Pv	215	mW			
Junction temperature		Тj	110	°C			
Ambient temperature range		T _{amb}	-40 to +110	°C			
Storage temperature range		T _{stg}	-40 to +110	°C			
Soldering temperature	According to reflow solder profile Fig. 8	T _{sd}	260	°C			
Thermal resistance junction to ambient	According to J-STD-051	R _{thJA}	270	K/W			



(e4) RoHS

COMPLIANT HALOGEN FREE GREEN (5-2008)

VEMD6110X01



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BASIC CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified)							
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT	
Forward voltage	I _F = 50 mA	V _F	-	1	-	V	
Breakdown voltage	I _R = 100 μA, E = 0	V _(BR)	32	-	-	V	
Reverse dark current	V _R = 10 V, E = 0	I _{ro}	-	1	3	nA	
Diode capacitance	$V_{R} = 0 V, f = 1 MHz, E = 0$	CD	-	12	-	pF	
	$V_{R} = 5 V, f = 1 MHz, E = 0$	CD	-	3.6	-	pF	
Open circuit voltage	$E_e = 1 \text{ mW/cm}^2$, $\lambda = 950 \text{ nm}$	Vo	-	356	-	mV	
Temperature coefficient of Vo	$E_e = 1 \text{ mW/cm}^2$, $\lambda = 950 \text{ nm}$	TK _{Vo}	-	-3.1	-	mV/K	
Short circuit current	$E_e = 1 \text{ mW/cm}^2$, $\lambda = 950 \text{ nm}$	l _k	-	9	-	μA	
Temperature coefficient of I_k	$E_e = 1 \text{ mW/cm}^2, \lambda = 950 \text{ nm}$	TK _{lk}	-	0.1	-	%/K	
Reverse light current	$E_e = 1 \text{ mW/cm}^2$, $\lambda = 950 \text{ nm}$, $V_R = 5 \text{ V}$	I _{ra}	6.7	9.5	12.4	μA	
Angle of half sensitivity		φ	-	± 60	-	0	
Wavelength of peak sensitivity		λρ	-	950	-	nm	
Range of spectral bandwidth		λ _{0.5}	750	-	1050	nm	
Rise time	V_R = 10 V, R_L = 1 k Ω , λ = 820 nm	t _r	-	100	-	ns	
Fall time	V_R = 10 V, R_L = 1 k Ω , λ = 820 nm	t _f	-	100	-	ns	

BASIC CHARACTERISTICS (Tamb = 25 °C, unless otherwise specified)

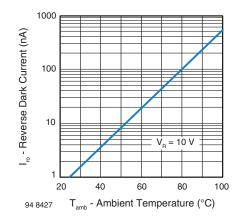


Fig. 1 - Reverse Dark Current vs. Ambient Temperature

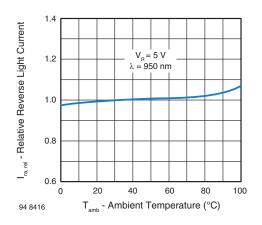


Fig. 2 - Relative Reverse Light Current vs. Ambient Temperature

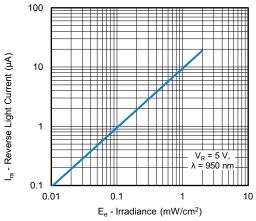
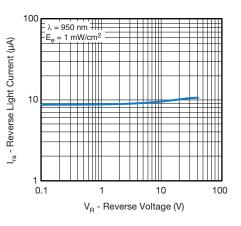


Fig. 3 - Reverse Light Current vs. Irradiance





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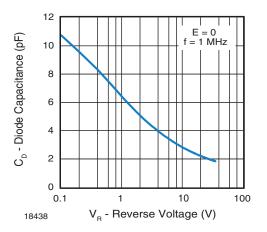


Fig. 5 - Diode Capacitance vs. Reverse Voltage

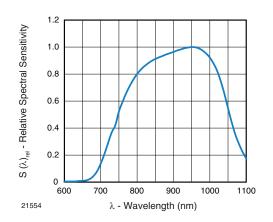


Fig. 6 - Relative Spectral Sensitivity vs. Wavelength

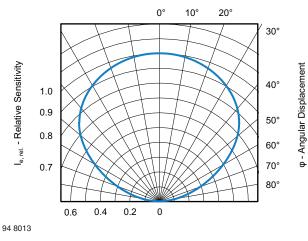
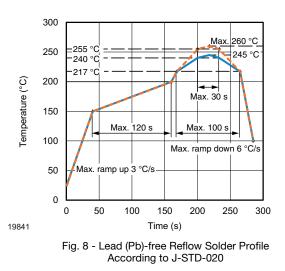


Fig. 7 - Relative Sensitivity vs. Angular Displacement

REFLOW SOLDER PROFILE



DRYPACK

Devices are packed in moisture barrier bags (MBB) to prevent the products from moisture absorption during transportation and storage. Each bag contains a desiccant.

FLOOR LIFE

Floor life (time between soldering and removing from MBB) must not exceed the time indicated on MBB label:

Floor life: 72 h

Conditions: T_{amb} < 30 °C, RH < 60 %

Moisture sensitivity level 4, acc. to J-STD-020.

DRYING

In case of moisture absorption devices should be baked before soldering. Conditions see J-STD-020 or label. Devices taped on reel dry using recommended conditions 192 h at 40 °C (+ 5 °C), RH < 5 %.

3

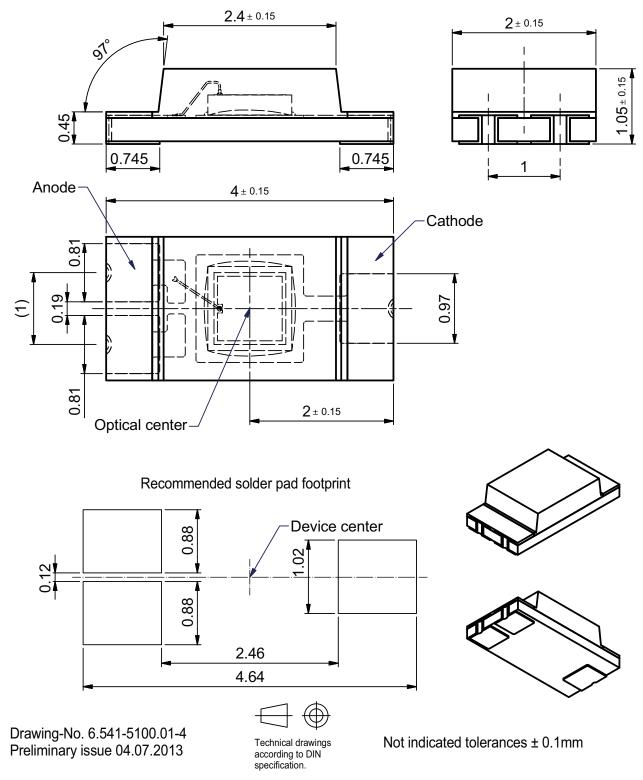


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PACKAGE DIMENSIONS in millimeters

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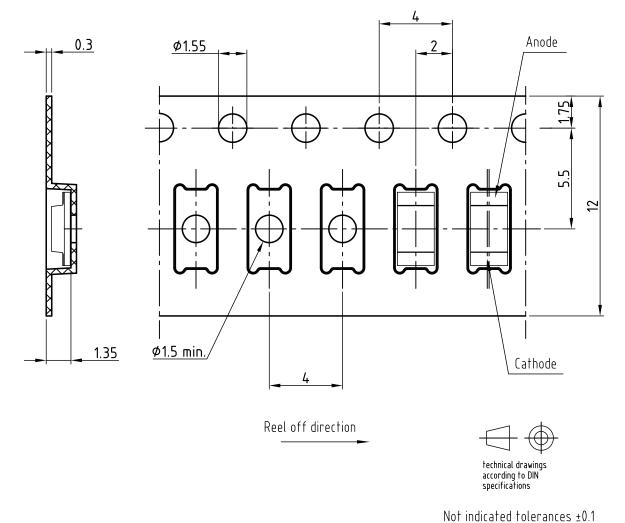
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BLISTER TAPE DIMENSIONS in millimeters



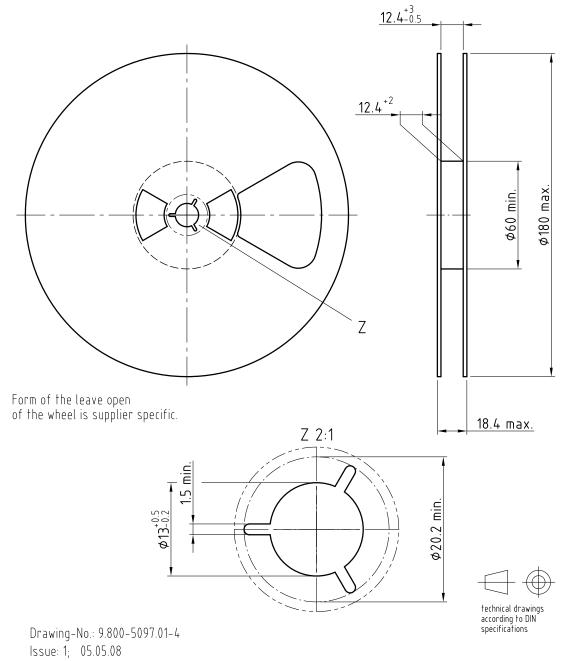
Drawing refers to following Types: TEMD6010FX01 VEMD6x10X01 Drawing-No.: 9.700-5329.02-4 VEMD6x15X01 Prel Issue: 16.07.2013 All dimensions in mm



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REEL DIMENSIONS in millimeters



20874



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Revision: 01-Jul-2024